



Docket No. 48832-CIP (71360)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: K. Takagi et al.

U.S.S.N.: 09/505,468

Examiner: D. Nakarani

Filed: 2/16/2000

Group: 1773

For: MULTILAYERED MOLDINGS

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**CERTIFICATE OF MAILING**

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service as first class mail in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450 on 12/11/03.

By: Eileen M Woodbury  
Eileen Woodbury

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Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**RESPONSE TO OFFICE ACTION**

The following is in response to the Office Action mailed October 6, 2003, in the above referenced application.

**Remarks/Arguments** begin on page 2 of this paper.